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(71) Applicant: QUALCOMM, INCORPORATED [US/US]; 5775 Morehouse Drive, San Diego, CA 92121 (US).

(72) Inventor: PRIMROSE, Paul W.; 11318 Matinal Circle, San Diego, CA 92127 (US).

(74) Agents: WADSWORTH, Philip R. et al.; 5775 Morehouse Drive, San Diego, CA 92121 (US).

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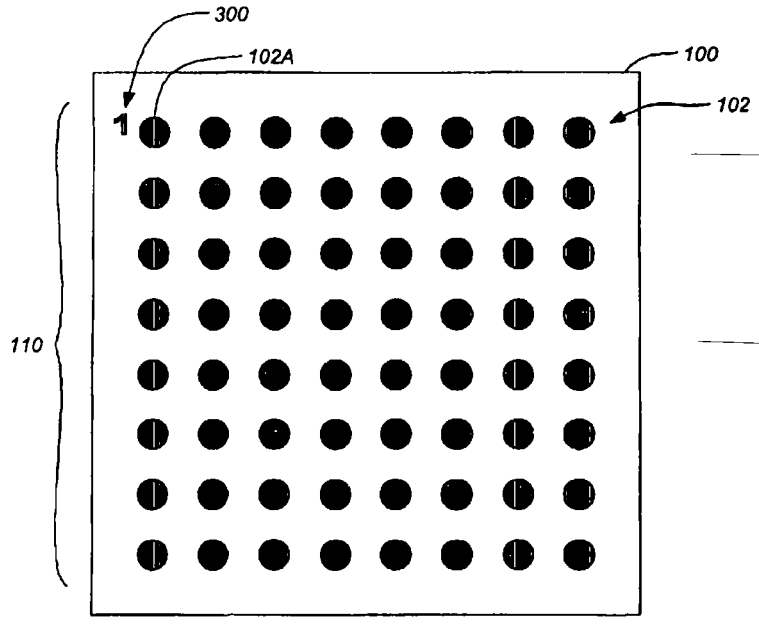
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(54) Title: BALL GRID ARRAY WITH X-RAY ALIGNMENT MARK



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ACTION

(57) Abstract: An apparatus and method for inspecting electronic component orientation along with x-ray verification of connection integrity is presented. An exemplary method comprises providing an electronic component 100 for surface mount integration and providing an x-ray visible orientation indicator 300, 402, 500, 600 for the electronic component 100 such that proper orientation of the electronic component 100 is verifiable by x-ray inspection after performing surface mount integration of the electronic component. The x-ray inspection also makes connection integrity of the electronic component 100 verifiable.

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